



Data Sheet

Customer: _____

Part No: _____

CL-SFC506BRIR-660,850-01

Sample No: _____

Description: _____

Item No: _____

Customer			
Check	Inspection	Approval	Date

Features:

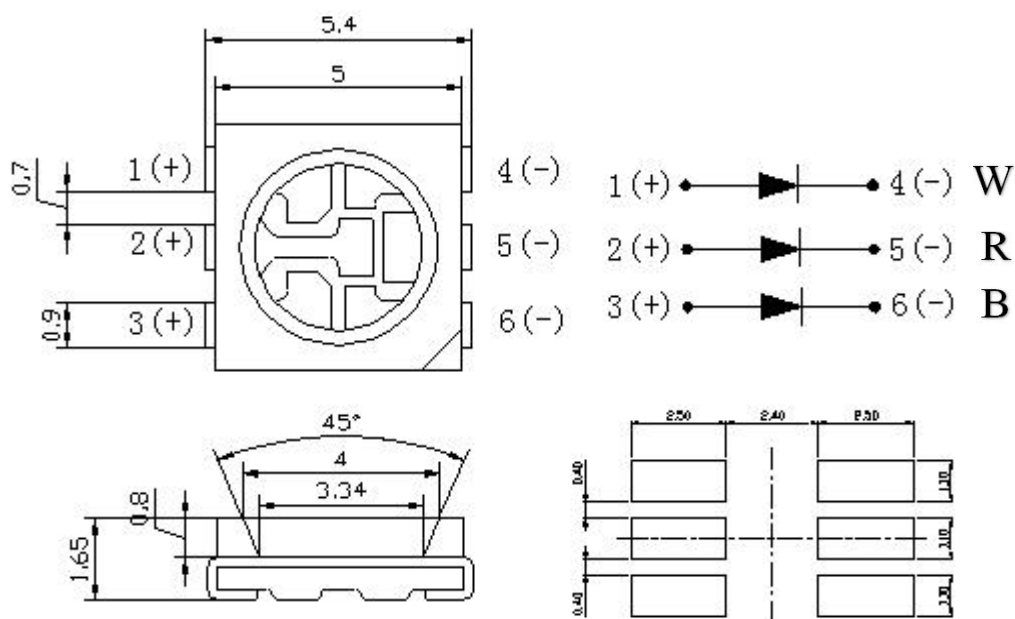
- . Reflow Solderable
- . High Luminous Intensity and Low Power Dissipation
- . Good Reliability and Long Life
- . Complied With RoHS Directive

Technical Data Sheet

This product is generally used as indicator and luminary for electronic equipment such as household appliance, communication equipment, and dashboard.

Applications

- Optical indicator
- Indoor display
- Backlighting in dashboard and switch
- Flat backlighting for LCD, symbol and display
- General use



Notes:

1. All dimension units are millimeters.
2. All dimension tolerance is $\pm 0.2\text{mm}$ unless otherwise noted.

Selection Guide

Part No.	Lens Type	Chip Materials	Luminous intensity(mcd) @ 20mA			Viewing Angle
			Min	Typ	Max	2θ1/2
CL-SFC506BRIR-660, 850-01	Water Clear	(B)InGaN	190	--	430	120
		(R)AlGaInP	160	--	350	
		Emission intensity (mW\sr)				
		(W)AlGaInP	2	--	6	

Note:

- 1.1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2.the above luminous intensity measurement allowance tolerance $\pm 10\%$

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Typ.	Max.	Units	test conditions
Forward Voltage	B	2.8	--	3.4	V	IF=20mA
	R	1.8	--	2.4		
	W	1.8	--	2.4		
Reverse Current	IR	--	--	10	uA	VR = 5V
Dominate Wavelength	B	460	--	465	nm	IF=20mA
	R	650	--	665		
	W	840	--	860		

Absolute Maximum Ratings at Ta=25°C

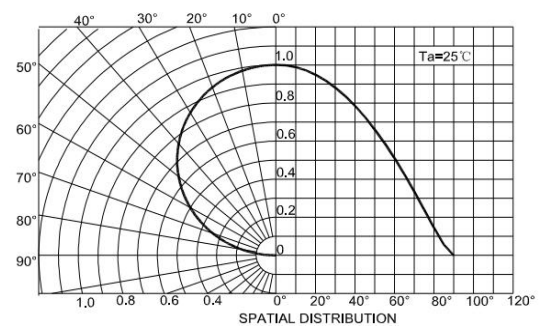
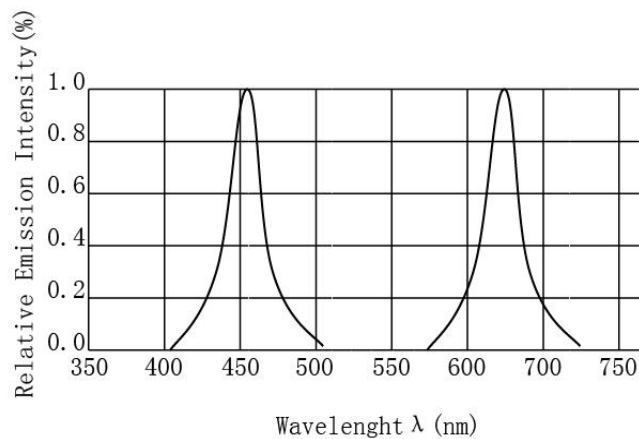
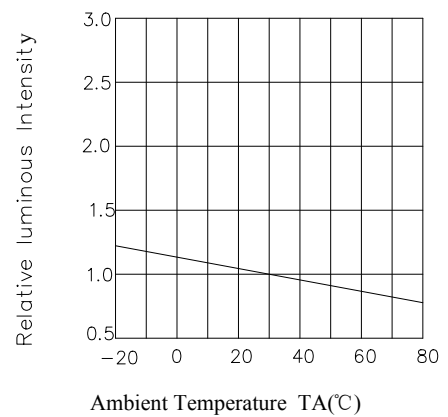
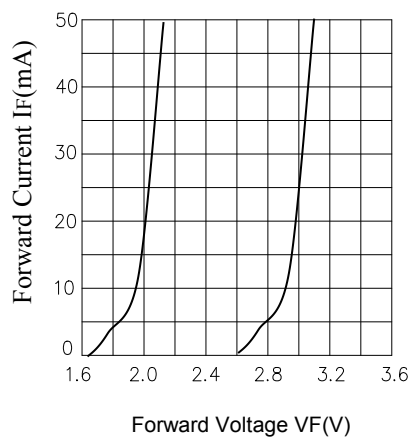
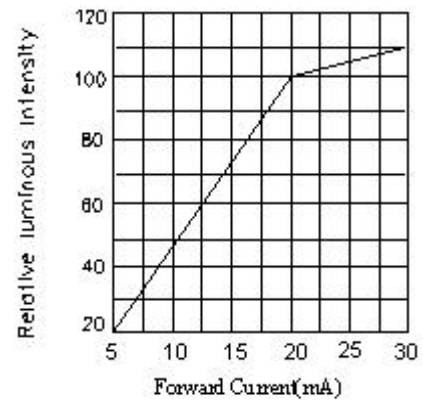
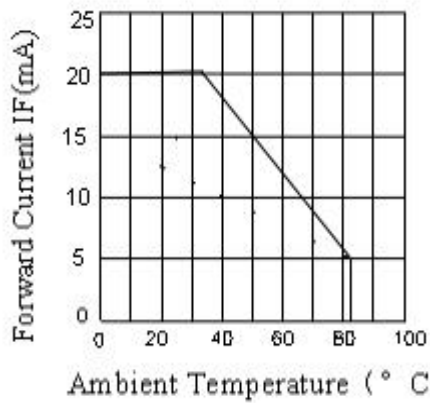
Parameter	Symbol	Rating	Units
Power Dissipation	B	68	mW
	R	48	
	W	48	
DC Forward Current	B	20	mA
	R	20	
	W	20	
Peak Forward Current [1]	B	75	mA
	R	75	
	W	75	
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C

Note:

1. 1/10 Dut cycle,0.1ms pulse width.
2. The above forward voltage measure ment allowance tolerance $\pm 0.1V$.
3. The tolerance of wave length: $\pm 1nm$,

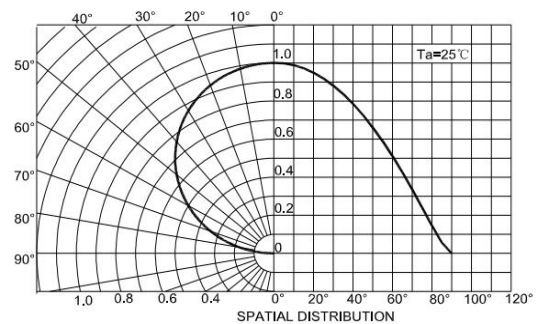
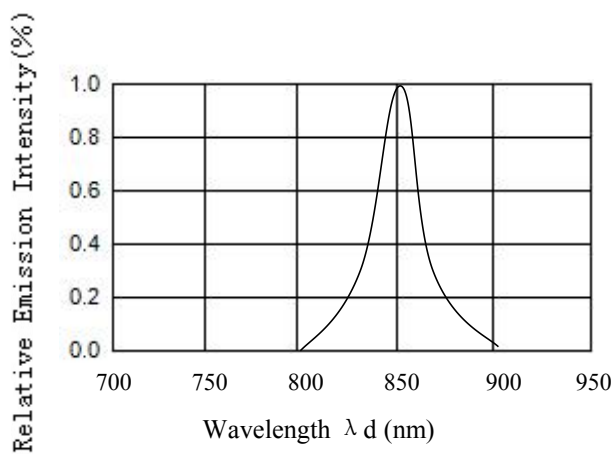
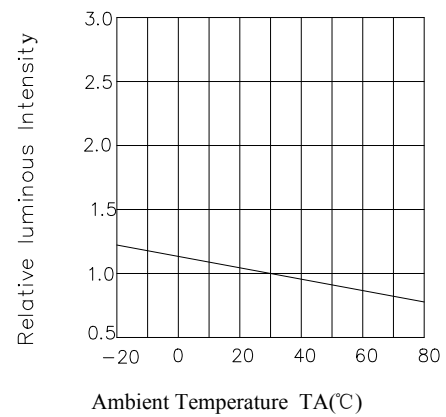
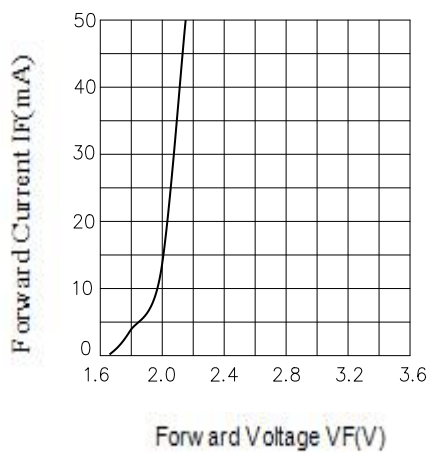
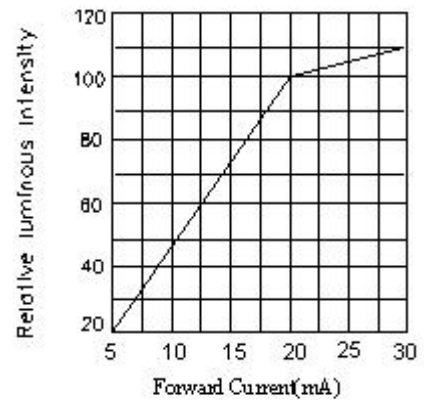
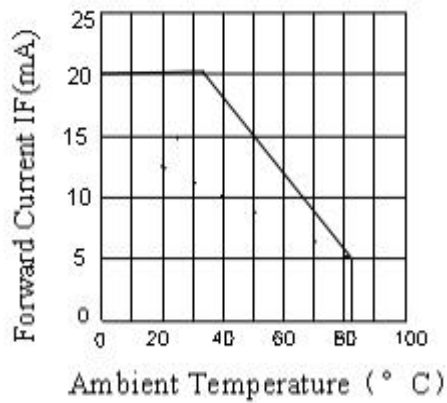
Typical optical characteristics curves

Ambient Temperature VS. Forward Current



Typical optical characteristics curves

Ambient Temperature VS. Forward Current



Reliability Test Items And Conditions

Test Items	Ref.Standard	Test conditions	Time	Quantity	Ac/Re
Reflow	JESD22-B106	Temp:260°C max T=10 sec	3 times.	22Pcs.	0/1
Temperature Cycle	JESD22-A104	-40°→30min 5 Cycles↑↓shift(5)min 100°C →30 min. 25°C~55°C	100 Cycles	22Pcs.	0/1
High Temperature Storage	JESD22-A103	Temp:100°C±5°C	1000Hrs	22Pcs.	0/1
Low Temperature Storage	JESD22-A119	Temp:-40°C±5°C	1000Hrs	22Pcs.	0/1
Life Test	JESD22-A108	Ta=25°C±5°C IF=20mA	1000Hrs	22Pcs.	0/1
High Temperature High Humidity Life Test	JESD22-A101	85°C±5°C/ 85%RH IF=20mA	1000Hrs	22Pcs.	0/1

Criteria For Judging Damage

Test Items	Symbol	Test conditions	Criteria For Judgement	
			Min.	Max.
Forward Voltage	VF	IF=20mA		U.S.L*)x1.1
Reverse Current	IR	VR = 5V		U.S.L*)x2.0
Luminous intensity	IV	IF=20mA	L.S.L*)x0.7	

U.S.L: Upper standard level

L.S.L: Lower standard level

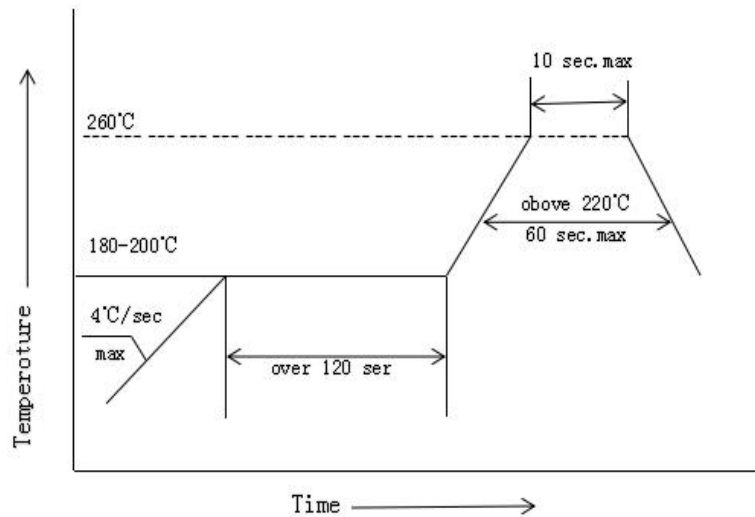
The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products.It does not constitute the warranting of industrial property nor the granting of any license.

SMT Reflow Soldering Instructions SMT

1.It is recommended that the reflow soldering should not be more than once.

If it is subjected to two high temperature processing, please finish in 24H.

2.When soldering , do not put stress on the LEDs during heating .



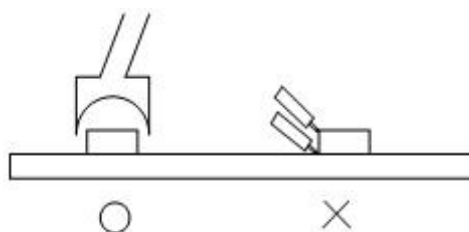
Soldering iron

1.When hand soldering, the temperature of the iron must less than 300°C for 3 seconds

2.The hand solder should be done only one times

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.



Storage

The package is sealed:

- 1.Recommended storage condition :At 5°C~30°C and relative humidity 90% RH max.
- 2.It is recommended that SMD out of their original packaging are used within one year.

The package is opened:

- 1.Completed within 24 hours.
- 2.Stored at 5°C~30°C and 60% RH or less.
- 3.LEDs stored more than 24 hours should be baked at about 65°C±5°C for at least 24 hours before solder assembly.

ESD

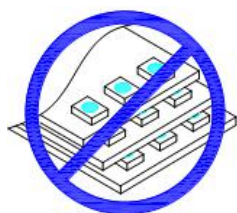
Static Electricity will damage the LED.

The following procedures may decrease the possibility of ESD damage.

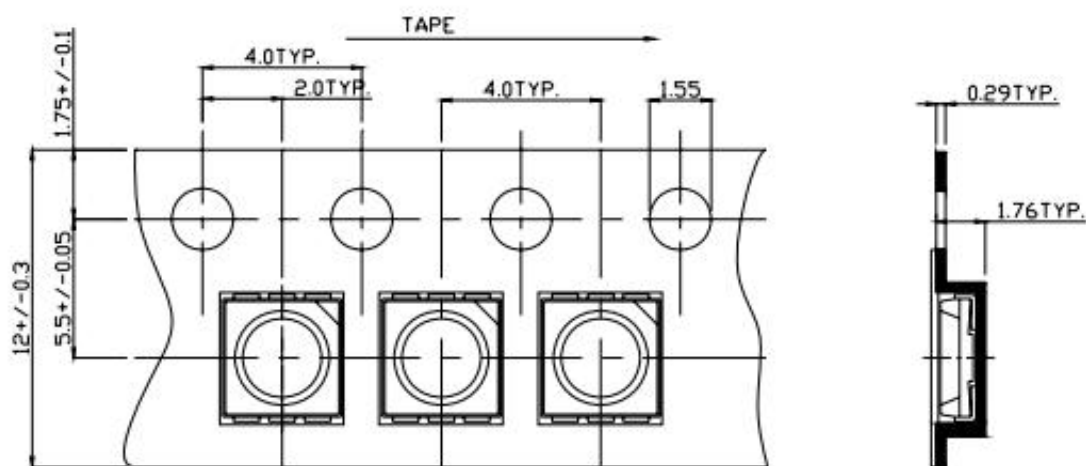
- 1.All productive machinery and test instruments must be electrically grounded.
- 2.Use a conductive wrist band or anti-electostatic glove when handling these LEDs.
- 3.Maintain a humidity level of 50%RH or higher in production areas.
- 4.Use anti-static packaging for transport and storage.

Handling Precautions

- 1.Do not stack together assembled PCBs containing LEDs. Impact may scratch the silicone lens or damage.
- 2.Not available in the situation of acidity for PH.
- 3.Electrostatic sensitive device



Package: 1000pcs/reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit: mm

Moisture Resistant Packaging

